

# **FGH30S130P** 1300 V, 30 A Shorted-anode IGBT

# **Features**

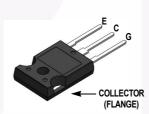
- · High Speed Switching
- Low Saturation Voltage: V<sub>CE(sat)</sub> = 1.75 V @ I<sub>C</sub> = 30 A
- High Input Impedance
- RoHS Compliant

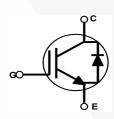
# Applications

• Induction Heating, Microwave Oven



Using advanced field stop trench and shorted-anode technology, Fairchild's shorted-anode trench IGBTs offer superior conduction and switching performances for soft switching applications. The device can operate in parallel configuration with exceptional avalanche capability. This device is designed for induction heating and microwave oven.





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	ol Description		Ratings	Unit V	
V <sub>CES</sub>	Collector to Emitter Voltage	1300			
V <sub>GES</sub>	Gate to Emitter Voltage		±25	V	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	60	A	
	Collector Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	30	A	
I <sub>CM (1)</sub>	Pulsed Collector Current		90	A	
lF	Diode Continuous Forward Current @ $T_C = 25^{\circ}C$		60	A	
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	30	A	
P <sub>D</sub>	Maximum Power Dissipation $@T_{C} = 25^{\circ}C$		500	W	
	Maximum Power Dissipation $@ T_C = 100^{\circ}C$		250	W	
Т <sub>Ј</sub>	Operating Junction Temperature		-55 to +175	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case, Max		0.3	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max		40	°C/W

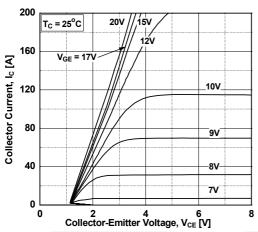
Notes: 1: Limited by Tjmax

November 2014

Device MarkingFGH30S130PF		Device	Package			Tape Width		Quantity 30	
		FGH30S130P	TO-247						
Electric	al Char	acteristics of th	e IGBT T <sub>C</sub> = 25	5°C unless otherwise noted	I				
Symbol		Parameter	Test	Conditions	Min.	Тур.	Max.	Unit	
Off Charac	teristics								
I <sub>CES</sub>	Collector 0	Cut-Off Current	V <sub>CE</sub> = 1300,	V <sub>CE</sub> = 1300, V <sub>GE</sub> = 0V		-	1	mA	
I <sub>GES</sub>	G-E Leakage Current		V <sub>GE</sub> = V <sub>GES</sub>	$V_{GE} = V_{GES}, V_{CE} = 0V$		-	±500	nA	
On Charac	teristics								
V <sub>GE(th)</sub>	G-E Threshold Voltage		I <sub>C</sub> = 30mA, V	$I_{\rm C}$ = 30mA, $V_{\rm CE}$ = $V_{\rm GE}$		6.0	7.5	V	
				I <sub>C</sub> = 30A, V <sub>GE</sub> = 15V		1.75	2.3	V	
V <sub>CE(sat)</sub> Collector to		o Emitter Saturation Volta		$T_{C} = 25^{\circ}C$ $I_{C} = 30A, V_{GE} = 15V,$ $T_{c} = 125^{\circ}C$		1.85	-	V	
				I <sub>C</sub> = 30A, V <sub>GE</sub> = 15V,		1.9	-	V	
V <sub>FM</sub>	Diode Forward Voltage		I <sub>F</sub> = 30A, T <sub>C</sub>	I <sub>F</sub> = 30A, T <sub>C</sub> = 25°C		1.7	2.2	V	
VFM Diode i orwa		and voltage	I <sub>F</sub> = 30A, T <sub>C</sub>	I <sub>F</sub> = 30A, T <sub>C</sub> = 175 <sup>o</sup> C		2.1	-	V	
Dynamic C	haracterist	ics							
C <sub>ies</sub>	Input Capa	acitance			-	3345	-	pF	
C <sub>oes</sub>	Output Ca	Output Capacitance		V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz		75	-	pF	
C <sub>res</sub>	Reverse T	ransfer Capacitance				60	-	pF	
Switching	Characcter	istics							
t <sub>d(on)</sub>	Turn-On Delay Time					39	-	ns	
t <sub>r</sub>	Rise Time					360	-	ns	
t <sub>d(off)</sub>	Turn-Off D	elay Time	V <sub>CC</sub> = 600V,	I <sub>C</sub> = 30A,	-	620	-	ns	
t <sub>f</sub>	Fall Time		R <sub>G</sub> = 10Ω, V		-	160	210	ns	
E <sub>on</sub>	Turn-On S	witching Loss	Resistive Lo	ad, T <sub>C</sub> = 25°C	-	1.3	-	mJ	
E <sub>off</sub>	Turn-Off S	witching Loss			-	1.22	1.6	mJ	
E <sub>ts</sub>	Total Swite	ching Loss			-	2.52	-	mJ	
t <sub>d(on)</sub>	Turn-On D	rn-On Delay Time			-	38	-	ns	
t <sub>r</sub>	Rise Time				-	375	-	ns	
t <sub>d(off)</sub>	Turn-Off D	elay Time	V <sub>CC</sub> = 600V,	I <sub>C</sub> = 30A,	-	635	-	ns	
t <sub>f</sub>	Fall Time		R <sub>G</sub> = 10Ω, V Resistive Lo	′ <sub>GE</sub> = 15V, ad, T <sub>C</sub> = 175ºC	-	270	-	ns	
Eon	Turn-On S	witching Loss		uu, 10 – 170 O	-	1.59	(	mJ	
E <sub>off</sub>	Turn-Off S	witching Loss			-	1.78	-	mJ	
E <sub>ts</sub>	Total Swite	ching Loss			-	3.37	-	mJ	
Qg	Total Gate		1/ - 0001/	1 - 20.4	-	372.3	-	nC	
Q <sub>ge</sub>	Gate to Er	nitter Charge	V <sub>CE</sub> = 600V, V <sub>GE</sub> = 15V	I <sub>C</sub> = 30A,	-	18.7	-	nC	
Q <sub>gc</sub>	Gate to Co	ollector Charge	• GE - 13 v		-	156.2	-	nC	



Figure 1. Typical Output Characteristics





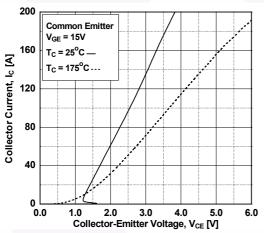
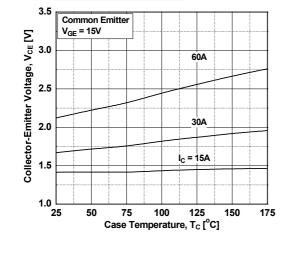


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level



**Figure 2. Typical Output Characteristics** 

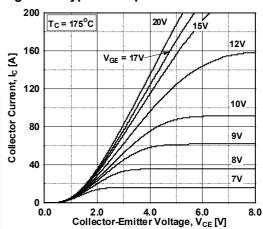


Figure 4. Transfer Characteristics

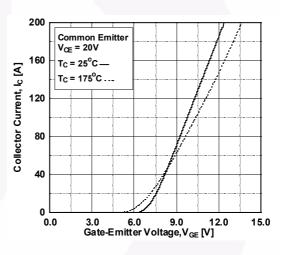
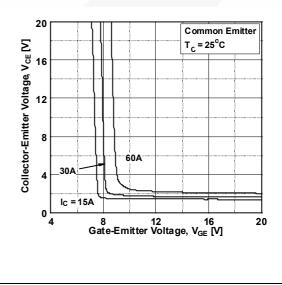
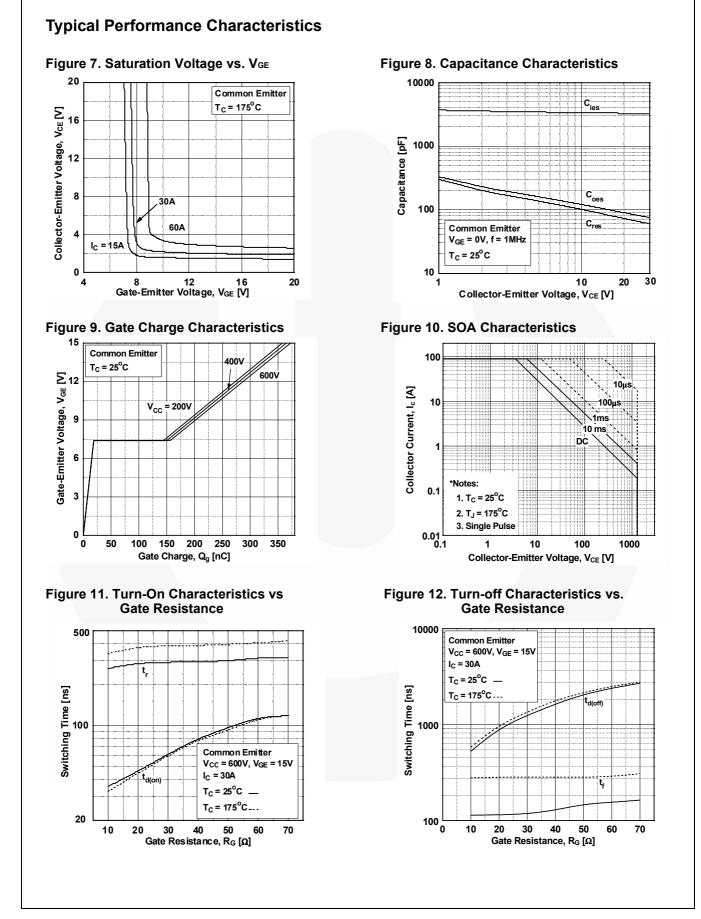


Figure 6. Saturation Voltage vs. VGE



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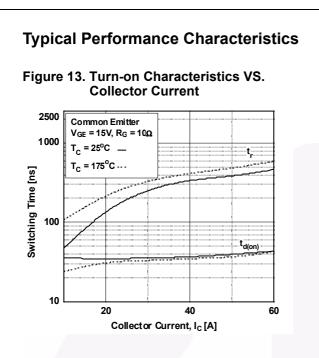


Figure 15. Switching Loss VS. Gate Resistance

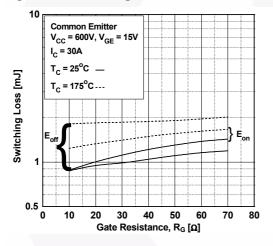


Figure 17. Turn off Switching SOA Characteristics

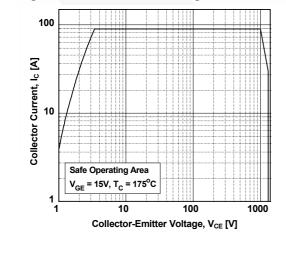


Figure 14.Turn-off Characteristics VS. Collector Current

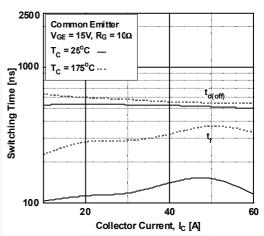
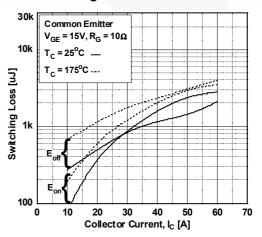
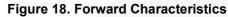
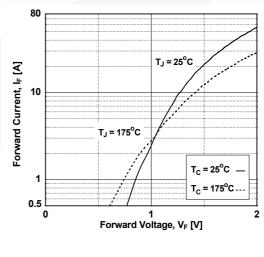


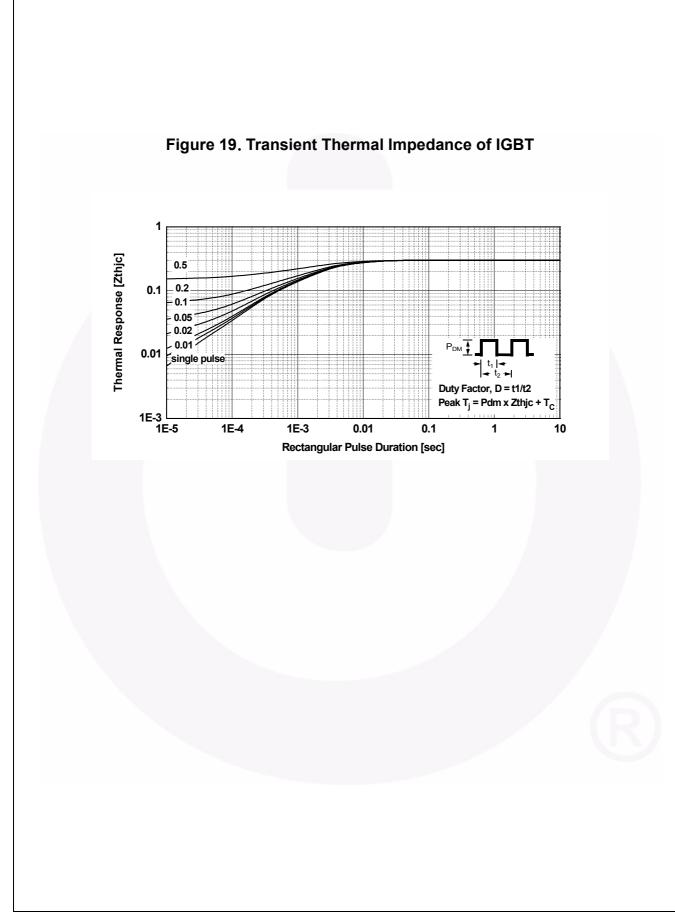
Figure 16. Switching Loss VS. Collector Current

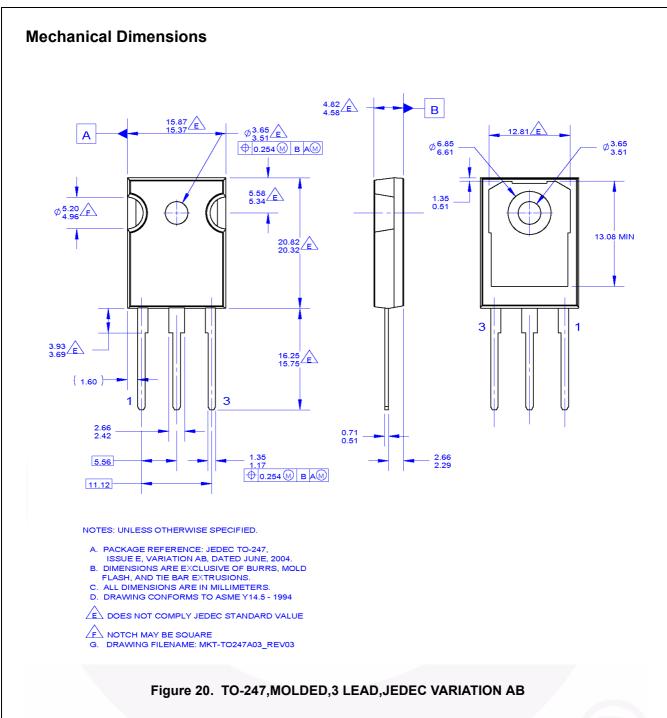






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**Dimensions in Millimeters** 

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